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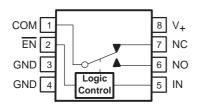
Description

The TS5A3153 is a single-pole double-throw (SPDT) analog switch that is designed to operate from 1.65 V to 5.5 V. The device offers a low ON-state resistance and an excellent on-resistance matching with the break-before-make feature, to prevent signal distortion during the transferring of a signal from one channel to another. The device has an excellent total harmonic distortion (THD) performance and consumes very low power. These features make this device suitable for portable audio applications.

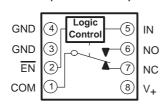
Applications

- Cell Phones
- PDAs
- Portable Instrumentation
- Audio and Video Signal Routing
- Low-Voltage Data Acquisition System
- Communication Circuits
- Modems
- Hard Drives
- Computer Peripherals
- Wireless Terminals and Peripherals

SSOP OR VSSOP PACKAGE (TOP VIEW)



YEA, YEP, YZA, OR YZP PACKAGE (BOTTOM VIEW)



Features

- Isolation in the Powered-Off Mode, V₊ = 0
- Specified Break-Before-Make Switching
- Low ON-State Resistance (1 Ω)
- Control Inputs Are 5.5-V Tolerant
- Low Charge Injection
- Excellent ON-State Resistance Matching
- Low Total Harmonic Distortion (THD)
- 1.65-V to 5.5-V Single-Supply Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)

Summary of Characteristics

 $V_{+} = 5 \text{ V}, T_{A} = 25^{\circ}\text{C}$

Configuration	2:1 Multiplexer/ Demultiplexer (SPDT)
Number of channels	1
ON-state resistance (ron)	1.1 Ω
ON-state resistance match (Δr _{on})	0.1 Ω
ON-state resistance flatness (ron(flat))	0.15 Ω
Turn-on/turn-of time (ton/toff)	20 ns/15 ns
Break-before-make time (t _{BBM})	12 ns
Charge injection (Q _C)	36 pC
Bandwidth (BW)	100 MHz
OFF isolation (OISO)	-65 dB at 1 MHz
Crosstalk (X _{TALK})	-66 dB at 1 MHz
Total harmonic distortion (THD)	0.01%
Leakageourrent(ICOM(OFF)/INO(OFF))	±20 nA
Power-supply current (I+)	0.1 μΑ
Package option	8-pin SSOP, VSSOP, or DSBGA

FUNCTION TABLE

EN	IN	NC TO COM, COM TO NC	NO TO COM, COM TO NO
L	L	ON	OFF
L	Н	OFF	ON
Н	Х	OFF	OFF



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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ORDERING INFORMATION

TA	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING(2)
	NanoStar [™] – WCSP (DSBGA) 0.17–mm Small Bump – YEA		TS5A3153YEAR	PREVIEW
	NanoFree™ – WCSP (DSBGA) 0.17-mm Small Bump – YZA (Pb-free)	To a condition	TS5A3153YZAR	PREVIEW
-40°C to 85°C	NanoStar [™] – WCSP (DSBGA) 0.23-mm Large Bump – YEP	Tape and reel	TS5A3153YEPR	PREVIEW
	NanoFree [™] – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)		TS5A3153YZPR	PREVIEW
	SSOP - DCT	Tape	TS5A3153DCT	PREVIEW
	VSSOP - DCU	Tape and reel	TS5A3153DCUR	JCD

⁽¹⁾ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package. (2) DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.

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Absolute Minimum and Maximum Ratings(1)(2)

over operating free-air temperature range (unless otherwise noted)

		37 113			
		4.0	MIN	MAX	UNIT
٧+	Supply voltage range(3)	2 1	-0.5	6.5	V
V _{NC} V _{NO} V _{COM}	Analog voltage range(3)(4)(5)	Tom.	-0.5	V ₊ + 0.5	V
ΙK	Analog port diode current	V _{NC} , V _{NO} , V _{COM} < 0	-50		mA
INC	On-state switch current)'	-200	200	
INO ICOM	On-state peak switch current(6)	V_{NC} , V_{NO} , $V_{COM} = 0$ to V_{+}	-400	400	mA
VI	Digital input voltage range(3)(4)		-0.5	6.5	V
liK	Digital input clamp current	V _I < 0	-50		mA
l ₊	Continuous current through V ₊			100	mA
I _{GND}	Continuous current through GND		-100	100	mA
		DCT package		220	
	Declare the maline adeas (7)	DCU package		227	0000
θ_{JA}	Package thermal impedance(7)	YEA/YZA package		140	°C/W
		YEP/YZP package		102	
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

- (2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
- (3) All voltages are with respect to ground, unless otherwise specified.
- (4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- (5) This value is limited to 5.5 V maximum.
- (6) Pulse at 1 ms duration < 10% duty cycle
- (7) The package thermal impedance is calculated in accordance with JESD 51-7.

YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).



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Electrical Characteristics for 5-V Supply⁽¹⁾

 $V_{+} = 4.5 \text{ V to } 5.5 \text{ V}, T_{A} = -40^{\circ}\text{C to } 85^{\circ}\text{C} \text{ (unless otherwise noted)}$

PARAMETER	SYMBOL	TEST CONDITIONS	3	TA	V ₊	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		٧+	V
Peak ON resistance	^r peak	$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = -100 \text{ mA},$	Switch ON, See Figure 13	25 °C Full	4.5 V		0.9	1.1	Ω
ON-state resistance	r _{on}	V_{NO} or $V_{NC} = 2.5 \text{ V}$, $I_{COM} = 100 \text{ mA}$,	Switch ON, See Figure 13	25°C Full	4.5 V		0.8	0.9	Ω
ON-state resistance match	Δr _{on}	V _{NO} or V _{NC} = 2.5 V, I _{COM} = 100 mA,	Switch ON, See Figure 13	25°C Full	4.5 V		0.05	0.10	Ω
between channels ON-state		$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = 100 \text{ mA},$	Switch ON, See Figure 13	25°C Full			0.15	0.10	 _
resistance flatness	^r on(flat)	V _{NO} or V _{NC} = 1 V, 1.5 V, 2.5 V, I _{COM} = 100 mA,	Switch ON, See Figure 13	25°C Full	4.5 V		0.09	0.15 0.15	Ω
NC, NO OFF leakage	INC(OFF), INO(OFF)	V _{NC} or V _{NO} = 1 V, V _{COM} = 4.5 V, or V _{NC} or V _{NO} = 4.5 V, V _{COM} = 1 V,	Switch OFF, See Figure 14	25°C Full	5.5 V	-20 -150	2	20 150	nA
current	INC(PWROFF), INO(PWROFF)	V _{NC} or V _{NO} = 0 to 5.5 V, V _{COM} = 5.5 V to 0,	Switch OFF, See Figure 14	25°C Full	0 V	-5 -25	0.7	5 25	μΑ
NC, NO ON leakage	INC(ON),	V_{NC} or $V_{NO} = 1$ V, $V_{COM} = Open$,	Switch ON,	25°C	5.5 V	-20	2	20	nA
current	INO(ON)	V _{NC} or V _{NO} = 4.5 V, V _{COM} = Open,	See Figure 15	Full		-150		150	
COM	I _{COM(OFF)}	V_{NC} or $V_{NO} = 4.5 \text{ V}$, $V_{COM} = 1 \text{ V}$, or V_{NC} or $V_{NO} = 1 \text{ V}$, $V_{COM} = 4.5 \text{ V}$,	Switch ON, See Figure 14	25°C Full	5.5 V	-20 -150	2	20 150	nA
OFF leakage current	COM(PWROFF)	V_{NC} or $V_{NO} = 0$ to 5.5 V,	Switch OFF,	25°C	0 V	-5	0.7	5	μΑ
	COIV(PVVROFF)	$V_{COM} = 5.5 \text{ V to 0},$	See Figure 14	Full	- V	-25		25	μΛ
COM ON leakage	ICOM(ON)	V_{NC} or V_{NO} = Open, V_{COM} = 1 V, or	Switch ON,	25°C	5.5 V	-20	2	20	nA
current	, ,	V_{NC} or V_{NO} = Open, V_{COM} = 4.5 V,	See Figure 15	Full	0.0 1	-150		150	
Digital Control Inputs (IN, EN)(2)									
Input logic high	V _{IH}			Full		2.4		5.5	V
Input logic low	V _{IL}			Full		0		8.0	V
Input leakage current	I _{IH} , I _{IL}	V _I = 5.5 V or 0		25°C Full	5.5 V	-100 -100	25	100	nA

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

⁽²⁾ All unused digital inputs of the device must be held at V₊ or GND to ensure proper device operation. Refer to the TI application report, *Implications* of Slow or Floating CMOS Inputs, literature number SCBA004.



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Electrical Characteristics for 5-V Supply⁽¹⁾ (continued) $V_+ = 4.5 \text{ V}$ to 5.5 V, $T_A = -40 ^{\circ}\text{C}$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	ONS	TA	٧+	MIN	TYP	MAX	UNIT
Dynamic				•					
Turn-on time	4	$V_{COM} = V_{+}$	C _L = 35 pF,	25°C	5 V	1	12.5	16	
rum-on ume	tON	$R_L = 50 \Omega$,	See Figure 17	Full	4.5 V to 5.5 V	1		17.5	ns
Turn-off time	torr	$V_{COM} = V_+,$	$C_{L} = 35 \text{ pF},$	25°C	5 V	2.5	8.5	15	ns
Tarri on time	^t OFF	$R_L = 50 \Omega$,	See Figure 17	Full	4.5 V to 5.5 V	2		18	115
Break-before-	t _{BBM}	$V_{NC} = V_{NO} = V_{+}$	$C_L = 35 pF$,	25°C	5 V	1	7	12	ns
make time	POIN	$R_L = 50 \Omega$,	See Figure 18	Full	4.5 V to 5.5 V	0.5		15	
Charge injection	QC	V _{GEN} = 0, R _{GEN} = 0, C _L = 1 nF,	See Figure 22	25°C	5 V		12		рС
NC, NO OFF capacitance	C _{NC(OFF)} , C _{NO(OFF)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF,	See Figure 16	25°C	5 V		19		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON,	See Figure 16	25°C	5 V		57		рF
COM OFF capacitance	C _{COM(OFF)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF,	See Figure 16	25°C	5 V		36		pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	See Figure 16	25°C	5 V		57		pF
Digital input capacitance	Cl	$V_I = V_+$ or GND,	See Figure 16	25°C	5 V		2		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 19	25°C	5 V		97		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, $f = 1 MHz$,	Switch OFF, See Figure 20	25°C	5 V		-64		dB
Crosstalk	XTALK	$R_L = 50 \Omega$, f = 1 MHz,	Switch ON, See Figure 21	25°C	5 V		-64		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 23	25°C	5 V		0.004		%
Supply									
Positive supply		$V_1 = V_+$ or GND,	Switch ON or	25°C	5.5 V		0.02	0.10	^
current	l ₊	v = v+ 01 GIND,	OFF	Full	5.5 V			0.50	μΑ

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



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Electrical Characteristics for 3.3-V Supply⁽¹⁾

 $V_{+} = 3 \text{ V to } 3.6 \text{ V}, T_{A} = -40^{\circ}\text{C to } 85^{\circ}\text{C (unless otherwise noted)}$

PARAMETER	SYMBOL	TEST CONDITIONS	S	TA	٧+	MIN	TYP	MAX	UNIT
Analog Switch	1								
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		٧+	V
Peak ON resistance	^r peak	$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = -100 \text{ mA},$	Switch ON, See Figure 13	25 °C Full	3 V		1.3	1.6	Ω
ON-state resistance	r _{on}	V _{NO} or V _{NC} = 2 V, I _{COM} = 100 mA,	Switch ON, See Figure 13	25°C Full	3 V		1.2	1.5	Ω
ON-state resistance match between channels	Δr _{on}	V _{NO} or V _{NC} = 2 V, 0.8 V I _{COM} = 100 mA,	Switch ON, See Figure 13	25°C Full	3 V		0.08	0.15 0.15	Ω
ON-state		$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = 100 \text{ mA},$	Switch ON, See Figure 13	25°C	0.1/		0.2		
resistance flatness	ron(flat)	V _{NO} or V _{NC} = 2 V, 0.8 V, I _{COM} = 100 mA,	Switch ON, See Figure 13	25°C Full	3 V		0.09	0.15 0.15	Ω
NC, NO	INO(OFF), INC(OFF)	V_{NC} or $V_{NO} = 1 \text{ V}, V_{COM} = 3 \text{ V},$	Switch OFF, See Figure 14	25°C	3.6 V	-20 -50	2	20 50	nA
OFF leakage current	INO(PWROFF), INC(PWROFF)	V _{NC} or V _{NO} = 3V, V _{COM} = 1 V, V _{NC} or V _{NO} = 0 to 3.6 V, V _{COM} = 3.6 V to 0,	Switch OFF, See Figure 14	25°C Full	0 V	-1 -15	0.2	1 15	μΑ
NC, NO ON leakage current	INC(ON), INO(ON)	V _{NC} or V _{NO} = 1 V, V _{COM} = Open, or V _{NC} or V _{NO} = 3 V, V _{COM} = Open,	Switch ON, See Figure 15	25°C Full	3.6 V	-20 -50	2	20 50	nA
COM	I _{COM(OFF)}	V_{NC} or $V_{NO} = 3 \text{ V}$, $V_{COM} = 1 \text{ V}$,	Switch ON, See Figure 14	25°C	3.6 V	-20 -50	2	20	nA
OFF leakage current	COM(PWROFF)	V _{NC} or V _{NO} = 1 V, V _{COM} = 3 V, V _{NC} or V _{NO} = 3.6 to 0 V, V _{COM} = 0 to 3.6 V,	Switch OFF, See Figure 14	25°C	0 V	-50 -1 -15	0.2	1 15	μΑ
COM ON leakage	ICOM(ON)	V _{NC} or V _{NO} = Open, V _{COM} = 1 V, or	Switch ON,	25°C	3.6 V	-20	2	20	nA
current	` ′	V_{NC} or V_{NO} = Open, V_{COM} = 3 V,	See Figure 15	Full		-50		50	
	igital Control Inputs (IN, EN)(2)		1	T					
Input logic high	VIH			Full		2		5.5	V
Input logic low	V _{IL}			Full		0		8.0	V
Input leakage current	I _{IH} , I _{IL}	V _I = 5.5 V or 0		25°C Full	3.6 V	-100 -100	25	100	nA

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

⁽²⁾ All unused digital inputs of the device must be held at V₊ or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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Electrical Characteristics for 3.3-V Supply⁽¹⁾ (continued) $V_+ = 3 \text{ V to } 3.6 \text{ V}, T_A = -40^{\circ}\text{C to } 85^{\circ}\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	ONS	T_{A}	٧+	MIN	TYP	MAX	UNIT
Dynamic	•				•				
Turn-on time		$V_{COM} = V_+,$	C _L = 35 pF,	25°C	3.3 V	1	17	22	
rum-on time	tON	$R_L = 50 \Omega$,	See Figure 17	Full	3 V to 3.6 V	1		24	ns
Turn-off time	torr	$V_{COM} = V_+,$	$C_L = 35 pF$,	25°C	3.3 V	4.3	9.5	16	nc
Tarri on time	tOFF	$R_L = 50 \Omega$,	See Figure 17	Full	3 V to 3.6 V	4		19	ns
Break-before-	toos	$V_{NC} = V_{NO} = V_+,$	$C_L = 35 pF$,	25°C	3.3 V	2	12	22	ns
make time	^t BBM	$R_L = 50 \Omega$,	See Figure 18	Full	3 V to 3.6 V	1		25	115
Charge injection	QC	V _{GEN} = 0, R _{GEN} = 0, C _L = 1 nF,	See Figure 22	25°C	3.3 V		8		рC
NC, NO OFF capacitance	C _{NC(OFF)} , C _{NO(OFF)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF,	See Figure 16	25°C	3.3 V		19		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON,	See Figure 16	25°C	3.3 V		57		pF
COM OFF capacitance	C _{COM(OFF)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF,	See Figure 16	25°C	3.3 V		36		pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	See Figure 16	25°C	3. 3 V		57		pF
Digital input capacitance	Cl	$V_I = V_+$ or GND,	See Figure 16	25°C	3.3 V		2		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 19	25°C	3.3 V		97		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, $f = 1 MHz$,	Switch OFF, See Figure 20	25°C	3.3 V		-64		dB
Crosstalk	XTALK	$R_L = 50 \Omega$, f = 1 MHz,	Switch ON, See Figure 21	25°C	3.3 V		-64		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 \text{ pF},$	f = 20 Hz to 20 kHz, See Figure 23	25°C	3.3 V		0.010		%
Supply									
Positive supply		W W as CND	Switch ON or	25°C	201/		0.01	0.10	
current	1+	$V_I = V_+ \text{ or GND},$	OFF	Full	3.6 V			0.25	μΑ

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



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Electrical Characteristics for 2.5-V Supply⁽¹⁾

 $V_{+} = 2.3 \text{ V to } 2.7 \text{ V}, T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C} \text{ (unless otherwise noted)}$

PARAMETER	SYMBOL	TEST CONDITIONS	;	TA	٧+	MIN	TYP	MAX	UNIT
Analog Switch	1								
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		٧+	٧
Peak ON resistance	^r peak	$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = -8 \text{ mA},$	Switch ON, See Figure 13	25 °C Full	2.3 V		1.9	2.5	Ω
ON-state resistance	r _{on}	V_{NO} or $V_{NC} = 1.8 \text{ V}$, $I_{COM} = 8 \text{ mA}$,	Switch ON, See Figure 13	25°C Full	2.3 V		1.6	2.1	Ω
ON-state resistance match between channels	Δr _{on}	V_{NO} or $V_{NC} = 0.8 \text{ V}$, $I_{COM} = 8 \text{ mA}$,	Switch ON, See Figure 13	25°C Full	2.3 V		0.12	0.2	Ω
ON-state		$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = 8 \text{ mA},$	Switch ON, See Figure 13	25°C			0.65		
resistance flatness	ron(flat)	V _{NO} or V _{NC} = 0.8 V, 1.8 V, I _{COM} = 8 mA,	Switch ON, See Figure 13	25°C Full	2.3 V		0.5	1	Ω
NO NO	INO(OFF), INC(OFF)	V_{NC} or $V_{NO} = 0.5 \text{ V}$, $V_{COM} = 2.2 \text{ V}$,	Switch Of I,	25°C	2.7 V	-20	2	20	nA
NC, NO OFF leakage		V_{NC} or $V_{NO} = 2.2 \text{ V}$, $V_{COM} = 0.5 \text{ V}$,	See Figure 14	Full		-50		50	
current	INO(PWROFF), INC(PWROFF)	$I_{NO(PWROFF)}$, V_{NC} or V_{NO} = 0 to 2.7 V, V_{COM} = 2.7 V to 0, V_{COM} See		25°C Full	0 V	-1 -10	0.1	10	μΑ
NC, NO ON leakage	INC(ON),	V_{NC} or $V_{NO} = 0.5 \text{ V}$, $V_{COM} = O_{Pen}$,	Switch ON,	25°C	2.7 V	-20	2	20	nA
current	INO(ON)	V_{NC} or $V_{NO} = 2.2 \text{ V}$, $V_{COM} = \text{Open}$,	See Figure 15	Full		-50		50	
COM	ICOM(OFF)	V_{NC} or $V_{NO} = 2.2 \text{ V}$, $V_{COM} = 0.5 \text{ V}$, or	Switch ON, See Figure 14	25°C	2.7 V	-20	2	20	nA
OFF leakage		$V_{NO} = 0.5 \text{ V}, V_{COM} = 2.2 \text{ V},$		Full		-50		50	
current	COM(PWROFF)	V_{NC} or $V_{NO} = 2.7 \text{ V to 0}$, $V_{COM} = 0 \text{ to } 2.7 \text{ V}$,	Switch OFF, See Figure 14	25°C Full	0 V	-1 -10	0.1	10	μΑ
COM ON leakage	loonyon	V_{NC} or V_{NO} = Open, V_{COM} = 0.5 V,	Switch ON,	25°C	2.7 V	-20	2	20	nA
current	ICOM(ON)	V_{NC} or V_{NO} = Open, V_{COM} = 2.2 V,	See Figure 15	Full	Z.1 V	-50		50	II/\
Digital Control Inpu	puts (IN, EN)(2)								
Input logic high	V _{IH}			Full		1.8		5.5	V
Input logic low	V _{IL}			Full		0		0.6	V
Input leakage current	liH, li⊏	V _I = 5.5 V or 0		25°C Full	2.7 V	-100 -100	25	100	nA

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

⁽²⁾ All unused digital inputs of the device must be held at V₊ or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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Electrical Characteristics for 2.5-V Supply⁽¹⁾ (continued) $V_+ = 2.3 \text{ V}$ to 2.7 V, $T_A = -40 \,^{\circ}\text{C}$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST COND	ITIONS	T_{A}	V ₊	MIN	TYP	MAX	UNIT
Dynamic									
Turn-on time	tou	$V_{COM} = V_+,$	C _L = 35 pF,	25°C	2.5 V	1.7	24	31	no
Turr on time	tON	$R_L = 50 \Omega$,	See Figure 17	Full	2.3 V to 2.7 V	1.5		33.5	ns
Turn-off time	tOFF	$V_{COM} = V_{+}$	$C_L = 35 pF$,	25°C	2.5 V	5.2	10.5	17	ns
	*OFF	$R_L = 50 \Omega$,	See Figure 17	Full	2.3 V to 2.7 V	5		20	110
Break-before-	t _{BBM}	$V_{NC} = V_{NO} = V_+,$	$C_L = 35 \text{ pF},$	25°C	2.5 V	3	10	30	ns
make time	-DDIVI	$R_L = 50 \Omega$,	See Figure 18	Full	2.3 V to 2.7 V	2		40	
Charge injection	QC	V _{GEN} = 0, R _{GEN} = 0, C _L = 1 nF,	See Figure 22	25°C	2.5 V		6		рС
NC, NO OFF capacitance	C _{NC(OFF)} , C _{NO(OFF)}	V _{NC} or V _{NO} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	2.5 V		19		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON,	See Figure 16	25°C	2.5 V		57		pF
COM OFF capacitance	CCOM(OFF)	V _{NC} or V _{NO} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	2.5 V		36		pF
COM ON capacitance	CCOM(ON)	V _{COM} = V ₊ or GND, Switch ON,	See Figure 16	25°C	2.5 V		57		pF
Digital input capacitance	Cl	$V_I = V_+$ or GND,	See Figure 16	25°C	2.5 V		2		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 19	25°C	2.5 V		100		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, $f = 1 \text{ MHz}$,	Switch OFF, See Figure 20	25°C	2.5 V		-64		dB
Crosstalk	XTALK	$R_L = 50 \Omega$, $f = 1 MHz$,	Switch ON, See Figure 21	25°C	2.5 V		-64		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 23	25°C	2.5 V		0.020		%
Supply									
Positive supply current	I ₊	$V_I = V_+$ or GND,	Switch ON or OFF	25°C Full	2.7 V		0.001	0.05 0.15	μА

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



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Electrical Characteristics for 1.8-V Supply⁽¹⁾

 $V_{+} = 1.65 \text{ V}$ to 1.95 V, $T_{A} = -40^{\circ}\text{C}$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		TA	٧+	MIN	TYP	MAX	UNIT
Analog Switch				•					
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		٧+	V
Peak ON resistance	^r peak	$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = -2 \text{ mA},$	Switch ON, See Figure 13	25°C Full	1.65 V		5.2	15 20	Ω
ON-state resistance	r _{on}	V _{NO} or V _{NC} = 1.5 V, I _{COM} = 2 mA,	Switch ON, See Figure 13	25°C Full	1.65 V		2	2.7	Ω
ON-state resistance match	∆r _{on}	V _{NO} or V _{NC} = 0.6 V, 1.5 V,	Switch ON,	25°C	1.65 V		0.16	0.3	Ω
between channels	011	ICOM = 2 mA,	See Figure 13	Full				0.3	
ON-state		$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = 2 \text{ mA},$	Switch ON, See Figure 13	25°C	4.05.1/		3		
resistance flatness	ron(flat)	V_{NO} or $V_{NC} = 0.6 \text{ V}$, 1.5 V, $I_{COM} = 2 \text{ mA}$,	Switch ON, See Figure 13	25°C Full	1.65 V		3	6 8	Ω
	INO(OFF),	V_{NC} or $V_{NO} = 0.3 \text{ V}$, $V_{COM} = 1.65 \text{ V}$,	Switch OFF,	25°C	Nor.V	-20	1.5	20	A
NC, NO OFF leakage	INC(OFF)	V_{NC} or $V_{NO} = 1.65 \text{ V}$, $V_{COM} = 0.3 \text{ V}$,	See Figure 14	Full	1.95 V	-50		50	nA
current	INO(PWROFF), INC(PWROFF)	V _{NC} or V _{NO} = 0 to 1.95 V, V _{COM} = 1.95 V to 0,	Switch OFF, See Figure 14	25°C Full	0 V	-1 -10	0.1	10	μΑ
NC, NO	I _{NC(ON)} ,	V_{NC} or $V_{NO} = 0.3 \text{ V}$, $V_{COM} = \text{Open}$,	Switch ON,	25°C		-20	1.5	20	
ON leakage current	INO(ON)	V_{NC} or $V_{NO} = 1.65 \text{ V}$, $V_{COM} = \text{Open}$,	See Figure 15	Full	1.95 V	-50		50	nA
0014	I _{COM(OFF)}	V_{NC} or $V_{NO} = 1.65 \text{ V}, V_{COM} = 0.3 \text{ V},$	Switch ON,	25°C	1.95 V	-20	1.5	20	nA
COM OFF leakage	"COM(OFF)	V_{NC} or $V_{NO} = 0.3 \text{ V}$, $V_{COM} = 1.65 \text{ V}$,	See Figure 14	Full	1.55 V	-50		50	11/4
current	COM(PWROFF)	V_{NC} or $V_{NO} = 1.95 \text{ V to 0}$, $V_{COM} = 0 \text{ to } 1.95 \text{ V}$,	Switch OFF, See Figure 14	25°C Full	0 V	-1 -10	0.06	10	μΑ
COM	`	V _{NC} or V _{NO} = Open, V _{COM} = 0.3 V,	Switch ON,	25°C		-20	1.5	20	
ON leakage current	ICOM(ON)	or V _{NC} or V _{NO} = Open, V _{COM} = 1.65 V,	See Figure 15	Full	1.95 V	-50		50	nA
Digital Control Inputs (IN, $\overline{\text{EN}}$)(2)			•						
Input logic high	VIH			Full		1.5		5.5	V
Input logic low	V _{IL}			Full		0		0.6	V
Input leakage current	I _{IH} , I _{IL}	V _I = 5.5 V or 0		25°C Full	1.95 V	-100 -100	25	100 100	nA
	l .	l .							

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

⁽²⁾ All unused digital inputs of the device must be held at V₊ or GND to ensure proper device operation. Refer to the TI application report, *Implications* of Slow or Floating CMOS Inputs, literature number SCBA004.



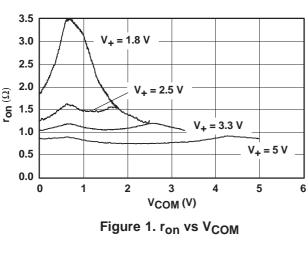
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Electrical Characteristics for 1.8-V Supply⁽¹⁾ (continued) $V_+ = 1.65 \text{ V}$ to 1.95 V, $T_A = -40 ^{\circ}\text{C}$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	ONS	TA	V ₊	MIN	TYP	MAX	UNIT
Dynamic	•								
Turn-on time	tou	$V_{COM} = V_+,$	C _L = 35 pF,	25°C	1.8 V	4.5	45	61	ns
Turr on time	tON	$R_L = 50 \Omega$,	See Figure 17	Full	1.65 V to 1.95 V	4		63	115
Turn-off time	tOFF	$V_{COM} = V_{+}$	$C_L = 35 pF$,	25°C	1.8 V	5.4	12	19	ns
	OFF	$R_L = 50 \Omega$,	See Figure 17	Full	1.65 V to 1.95 V	5		21	110
Break-before- make time	t _{BBM}	$V_{NC} = V_{NO} = V_{+}$	C _L = 35 pF,	25°C	1.8 V	4	31	60	ns
make lime	BBIVI	$R_L = 50 \Omega$	See Figure 18	Full	1.65 V to 1.95 V	3		65	
Charge injection	QC	V _{GEN} = 0, R _{GEN} = 0, C _L = 1 nF,	See Figure 22	25°C	1.8 V		4		рС
NC, NO OFF capacitance	C _{NC(OFF)} , C _{NO(OFF)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF,	See Figure 16	25°C	1.8 V		19		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON,	See Figure 16	25°C	1.8 V		57		pF
COM OFF capacitance	C _{COM(OFF)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF,	See Figure 16	25°C	1.8 V		36		pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	See Figure 16	25°C	1.8 V		57		pF
Digital input capacitance	Cl	$V_I = V_+$ or GND,	See Figure 16	25°C	1.8 V		2		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 19	25°C	1.8 V		100		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, f = 1 MHz,	Switch OFF, See Figure 20	25°C	1.8 V		-64		dB
Crosstalk	X _{TALK}	$R_L = 50 \Omega$, $f = 1 MHz$,	Switch ON, See Figure 21	25°C	1.8 V		-64		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 23	25°C	1.8 V		0.060		%
Supply									
Positive supply	I ₊	$V_I = V_+$ or GND,	Switch ON or	25°C	1.95 V		0.001	0.05	μА
current	'+	VI - V+ OI GIND,	OFF	Full	1.50 V			0.1	μΑ

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

TYPICAL PERFORMANCE



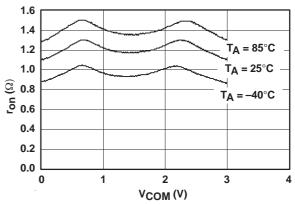


Figure 2. r_{on} vs V_{COM} ($V_{+} = 3 V$)

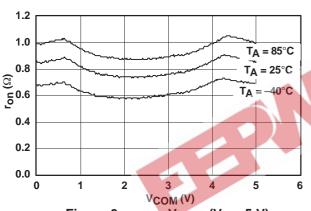
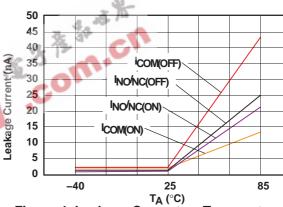


Figure 3. r_{on} vs V_{COM} ($V_{+} = 5$ V)



T_A (°C)
Figure 4. Leakage Current vs Temperature
(V₊ = 5.5 V)

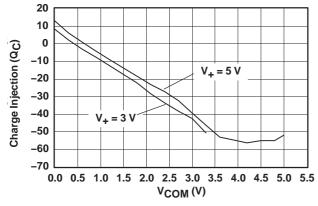


Figure 5. Charge Injection (Q_C) vs V_{COM}

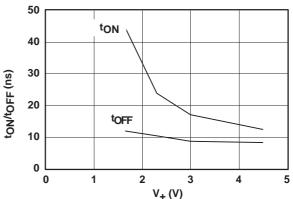


Figure 6. t_{ON} and t_{OFF} vs Supply Voltage



TYPICAL PERFORMANCE

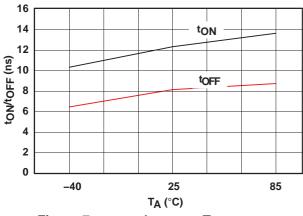


Figure 7. t_{ON} and t_{OFF} vs Temperature (V₊ = 4.5 V)

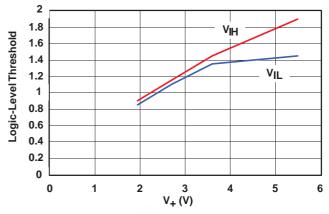


Figure 8. Logic-Level Threshold vs V₊

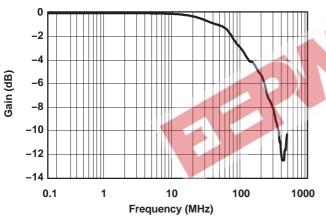


Figure 9. Bandwidth (Gain vs Frequency) $(V_+ = 5 V)$

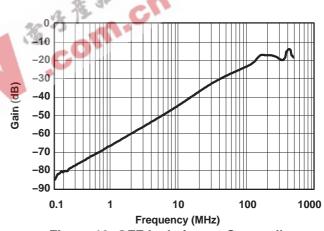


Figure 10. OFF Isolation vs Crosstalk $(V_+ = 5 V)$

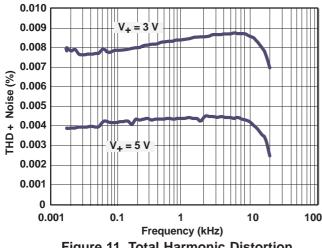


Figure 11. Total Harmonic Distortion vs Frequency

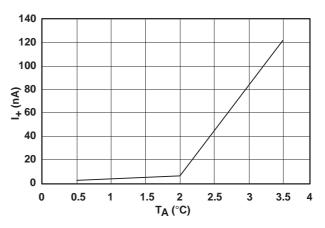


Figure 12. Power-Supply Current vs Temperature (V = 5 V)



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PIN DESCRIPTION

PIN NUMBER	NAME	DESCRIPTION	
1	COM	Common	
2	EN	Enable control input	
3	GND	Digital ground	
4	GND	Digital ground	
5	IN	Digital control to connect COM to NO or NC	
6	NO	Normally open	
7	NC	Normally closed	
8	V ₊	Power supply	

PARAMETER DESCRIPTION

SYMBOL	DESCRIPTION				
VCOM	Voltage at COM				
V _{NC}	Voltage at NC				
V _{NO}	Voltage at NO				
r _{on}	Resistance between COM and NC or COM and NO ports when the channel is ON				
r _{peak}	Peak on-state resistance over a specified voltage range				
Δr_{on}	Difference of ron between channels in a specific device				
ron(flat)	Difference between the maximum and minimum value of ron in a channel over the specified range of conditions				
I _{NC} (OFF)	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the OFF state under worst-case input and output conditions				
INC(PWROFF)	Leakage current measured at the NC port during the power-off condition, V ₊ = 0				
INO(OFF)	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state under worst-case input and output conditions				
INO(PWROFF)	Leakage current measured at the NO port during the power-off condition, $V_{+} = 0$				
INC(ON)	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the ON state and the output (COM) open				
I _{NO(ON)}	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) open				
ICOM(ON)	Leakage current measured at the COM port, with the corresponding channel (COM to NO or COM to NC) in the ON state and the output (NC or NO) open				
ICOM(OFF)	Leakage current measured at the COM port, with the corresponding channel (COM to NO or COM to NC) in the OFF state and the output (NC or NO) open				
ICOM(PWROFF)	Leakage current measured at the COM port during the power-off condition, $V_{+} = 0$				
VIH	Minimum input voltage for logic high for the control input (IN, EN)				
V _{IL}	Maximum input voltage for logic low for the control input (IN, EN)				
VI	Voltage at the control input (IN, EN)				
I _{IH} , I _{IL}	Leakage current measured at the control input (IN, EN)				
tON	Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM, NC, or NO) signal when the switch is turning ON.				
tOFF	Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM, NC, or NO) signal when the switch is turning OFF.				
^t BBM	Break-before-make time. This parameter is measured under the specified range of conditions and by the propagation delay between the output of two adjacent analog channels (NC and NO) when the control signal changes state.				
QC	Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NC, NO, or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_{COM}$, C_L is the load capacitance, and ΔV_{COM} is the change in analog output voltage.				



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PARAMETER DESCRIPTION (continued)

SYMBOL	DESCRIPTION
C _{NC(OFF)}	Capacitance at the NC port when the corresponding channel (NC to COM) is OFF
C _{NO(OFF)}	Capacitance at the NO port when the corresponding channel (NO to COM) is OFF
C _{NC(ON)}	Capacitance at the NC port when the corresponding channel (NC to COM) is ON
C _{NO(ON)}	Capacitance at the NO port when the corresponding channel (NO to COM) is ON
CCOM(ON)	Capacitance at the COM port when the corresponding channel (COM to NC or COM to NO) is ON
C _{COM(OFF)}	Capacitance at the COM port when the corresponding channel (COM to NC or COM to NO) is OFF
Cl	Capacitance of control input (IN, EN)
O _{ISO}	OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NC to COM or NO to COM) in the OFF state.
XTALK	Crosstalk is a measurement of unwanted signal coupling from an ON channel to an OFF channel (NC to NO or NO to NC). This is measured in a specific frequency and in dB.
BW	Bandwidth of the switch. This is the frequency in which the gain of an ON channel is –3 dB below the DC gain.
THD	Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.
l ₊	Static power-supply current with the control (IN, EN) pin at V ₊ or GND



PARAMETER MEASUREMENT INFORMATION

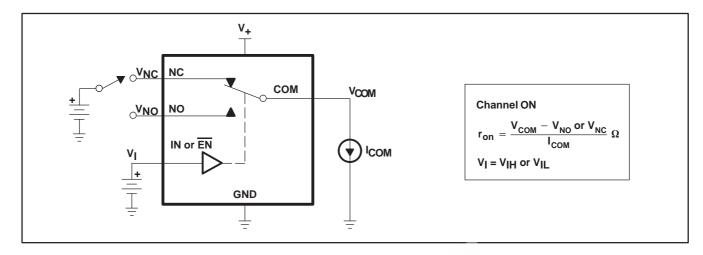
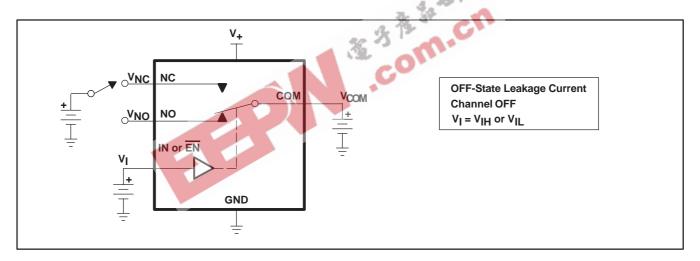


Figure 13. ON-State Resistance (ron)



 $\textbf{Figure 14. OFF-State Leakage Current (I_{NC(OFF)}, I_{NC(PWROFF)}, I_{NO(OFF)}, I_{NO(PWROFF)}, I_{COM(PWROFF)}) } \\$

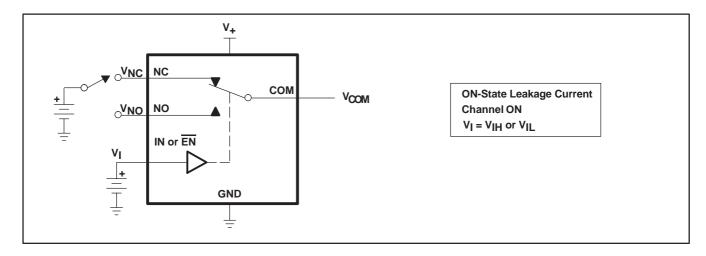


Figure 15. ON-State Leakage Current ($I_{COM(ON)}$, $I_{NC(ON)}$, $I_{NO(ON)}$)



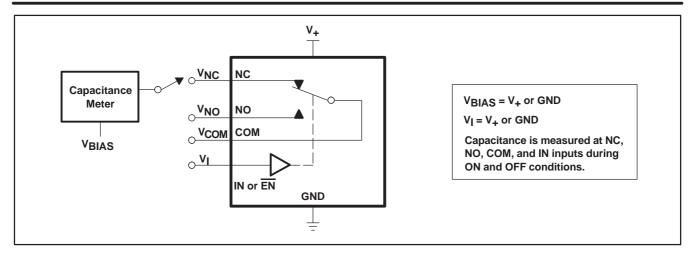
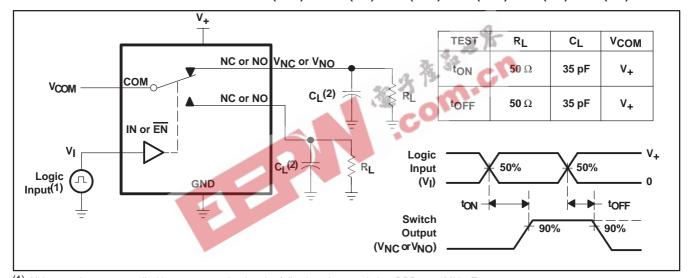


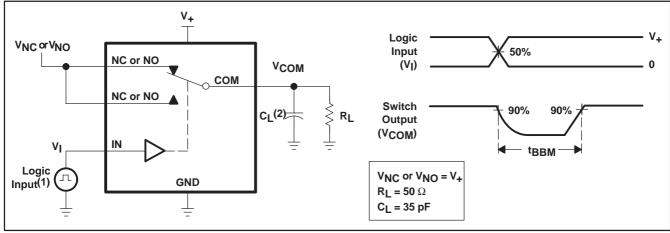
Figure 16. Capacitance (C_I, C_{COM(OFF)}, C_{COM(ON)}, C_{NC(OFF)}, C_{NO(OFF)}, C_{NO(ON)})



(1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f < 5$ ns.

(2) C_L includes probe and jig capacitance.

Figure 17. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})



(1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{O} = 50 Ω , t_{r} < 5 ns, t_{f} < 5 ns.

(2) C_I includes probe and jig capacitance.

Figure 18. Break-Before-Make Time (t_{BBM})

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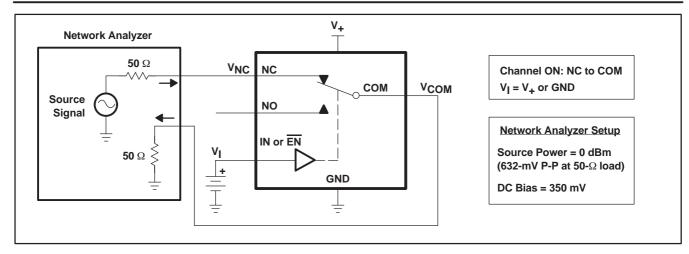


Figure 19. Bandwidth (BW)

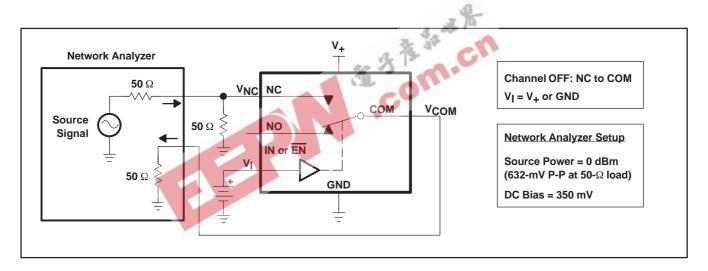


Figure 20. OFF Isolation (OISO)

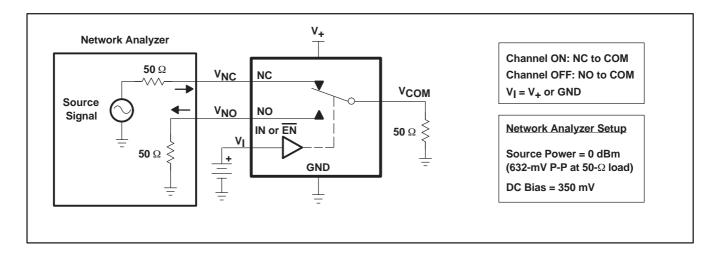
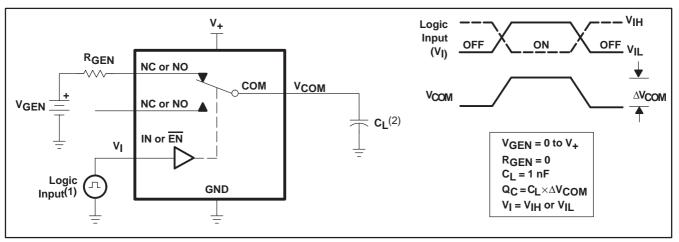


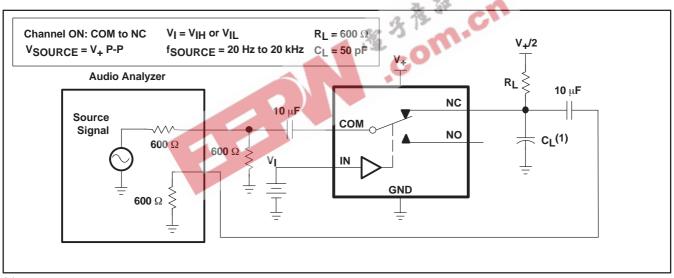
Figure 21. Crosstalk (X_{TALK})





- (1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_Q = 50 \Omega$, $t_f < 5$ ns, $t_f < 5$ ns.
- (2) C_L includes probe and jig capacitance.

Figure 22. Charge Injection (Q_C)



(1) C_I includes probe and jig capacitance.

Figure 23. Total Harmonic Distortion (THD)



PACKAGE OPTION ADDENDUM

14-Nov-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TS5A3153DCUR	ACTIVE	US8	DCU	8	3000	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM
TS5A3153DCURE4	ACTIVE	US8	DCU	8	3000	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

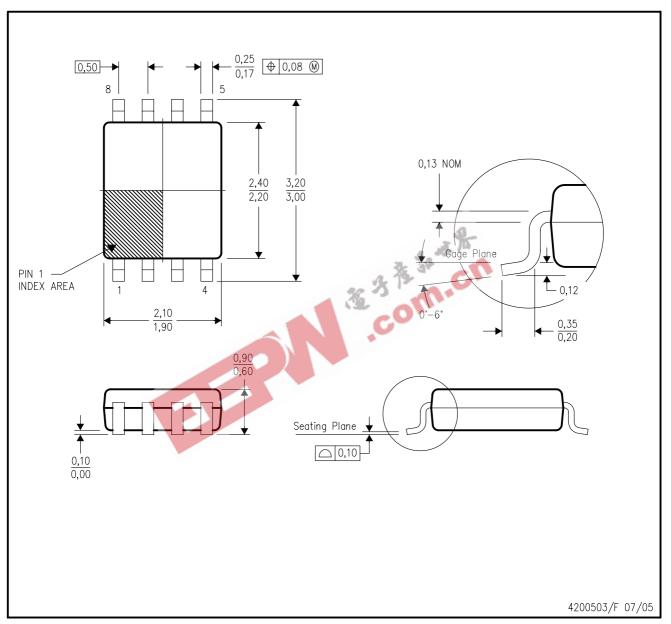
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DCU (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-187 variation CA.



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